

HZ-LL Series

Silicon Planar Zener Diode for Hard Knee Low Noise

REJ03G0183-0300

Rev.3.00

Nov 08, 2007

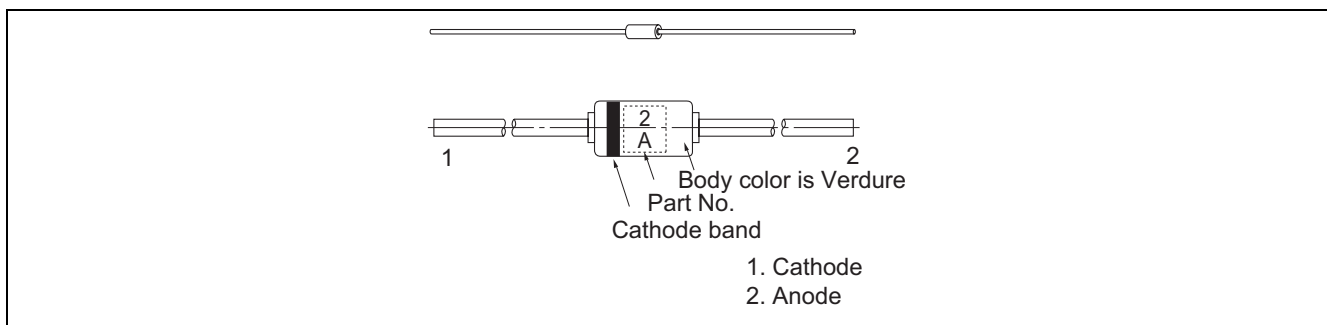
Features

- V_Z - I_Z characteristics are semi logarithmic linear from $I_Z = 1$ nA to 1 mA and have sharper breakdown knees in a low current region, and also lower V_Z temperature coefficients.
- Low dynamic impedance and low noise in the low current region (approximately 1/10 lower than the current zeners).

Ordering Information

Part No.	Cathode Band	Package Name	Package Code
HZ-LL Series	Navy blue	DO-35	GRZZ0002ZB-A

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

tem	Symbol	Value	Unit
Power dissipation	Pd	250	mW
Junction temperature	Tj	175	°C
Storage temperature	Tstg	-55 to +175	°C

Electrical Characteristics

(Ta = 25°C)

Part No.	Zener Voltage		Reverse Current			Dynamic Resistance				Linearity ^{*3}	
	Vz(V) ^{*1}		Iz (mA)	IR (nA)		ZzT (Ω)		ZzK (Ω) ^{*2}		ΔVz1 (V)	ΔVz2(V)
	Min	Max		Max	V _R (V)	Max	IzT (mA)	Typ	IzK (μA)	Max	Max
HZ2ALL	1.6	2.0	0.5	100	0.5	350	0.5	(1.2)	50	0.5	0.6
HZ2BLL	1.9	2.3									
HZ2CLL	2.2	2.6									
HZ3ALL	2.5	2.9	0.5	100	1.0	360	0.5	(1.2)	50	0.5	0.6
HZ3BLL	2.8	3.2									
HZ3CLL	3.1	3.5									
HZ4ALL	3.4	3.8	0.5	100	2.0	370	0.5	(1.5)	50	0.5	0.6
HZ4BLL	3.7	4.1									
HZ4CLL	4.0	4.4									
HZ5ALL	4.3	4.7	0.5	100	3.0	380	0.5	(1.5)	50	0.5	0.6
HZ5BLL	4.6	5.0									
HZ5CLL	4.9	5.3									

Notes: 1. Tested with DC.

2. Reference only.

3. $\Delta V_{z1} = V_z (I_z = 0.5 \text{ mA}) - V_{z1} (I_z = 0.05 \text{ mA})$ $\Delta V_{z2} = V_{z1} (I_z = 0.05 \text{ mA}) - V_{z2} (I_z = 0.001 \text{ mA})$

Main Characteristic

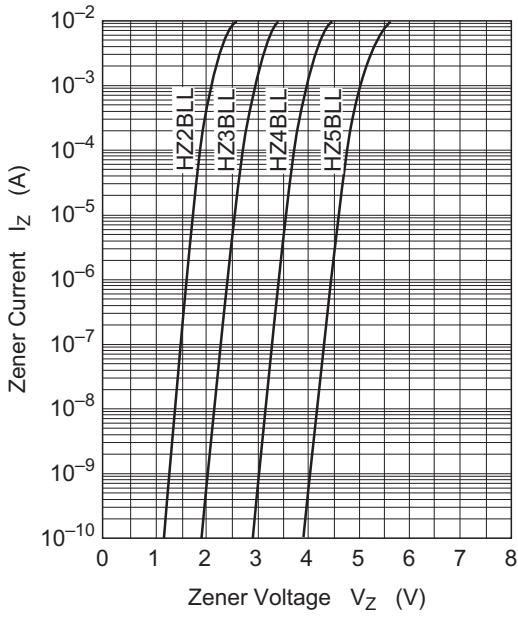


Fig.1 Zener current vs. Zener voltage

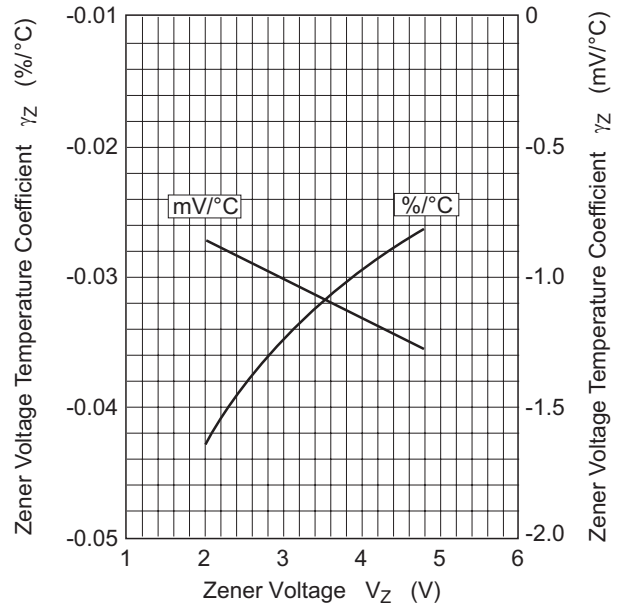


Fig.2 Temperature Coefficient vs. Zener voltage

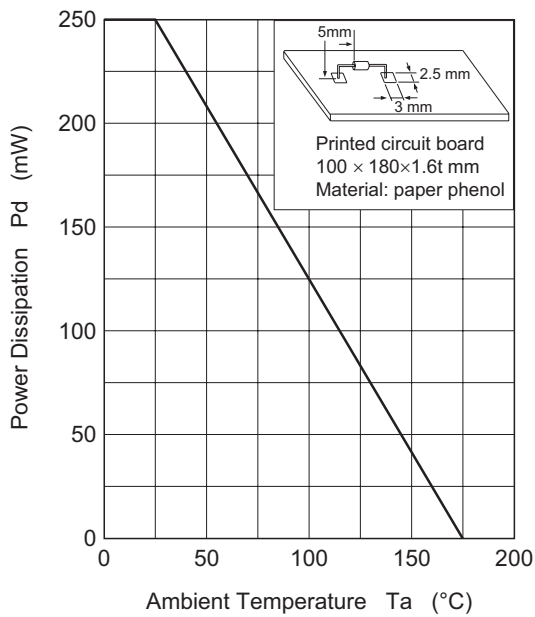
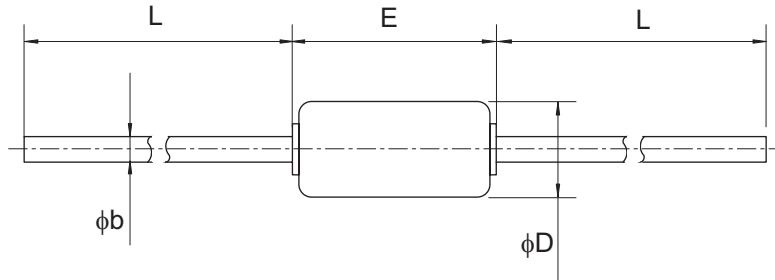


Fig.3 Power Dissipation vs. Ambient Temperature

Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
DO-35	SC-40	GRZZ0002ZB-A	DO-35 / DO-35V	0.13g



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
ϕb	-	0.5	-
ϕD	-	2.0	-
E	-	-	4.2
L	26.0	-	-

Notes:

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